30V N-Channel Enhancement Mode MOSFET

Description

The PECN3065D6 uses advanced trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g. This device is ideal for high-frequency switching and synchronous rectification.

General Features

- V_{DS} =30V I_D =65A
  $R_{DS(ON)}$(Typ.)=6.3mΩ   @V_{GS}=10V
  $R_{DS(ON)}$(Typ.)=8.8mΩ   @V_{GS}=4.5V
- Excellent gate charge x $R_{DS(on)}$ product(FOM)
- Very low on-resistance $R_{DS(on)}$
- 150 °C operating temperature
- 100% UIS tested

100% UIS TESTED!

100% ΔVds TESTED!

Application

- Synchronus Rectification in DC/DC and AC/DC Converters
- Industrial and Motor Drive applications

Schematic diagram

D

G

S
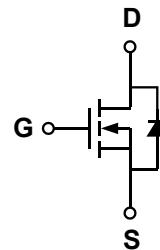
Marking and pin assignment

PDFN5*6-8L-A

D D D D

3065
XXXX
YYYYY

S S S G

Top View

D D D D

G S S S
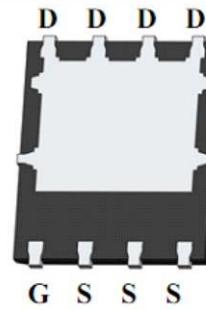
Bottom View

XXXXX—Wafer Information YYYYY—Quality Code

RoHS HF Pb

Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
PECN3065D6-G	-55°C to +150°C	PDFN5*6-8L-A	5000

Absolute Maximum Ratings (TA=25℃ unless otherwise noted)

parameter		symbol	limit	unit
Drain-source voltage		V_{DS}	30	V
Gate-source voltage		V_{GS}	±20	V
Continuous Drain Current	TC=25°C	I_D	65	A
	TC=70°C		50	
Pulsed Drain Current		I_{DP}	200	A
Avalanche energy(T_j=25℃ ,V_{DD}=30V,V_G=10V,L=0.5mH,Rg=25Ω)		E_{AS}	150	mJ
Power Dissipation	TC=25°C	P_D	65	W
	TC=70°C		40	
Operating junction Temperature range		Tj	-55—150	℃

Electrical Characteristics (TA=25℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{GS}=0V$, $I_D=250\mu A$	30	-	-	V
Zero gate voltage drain current	I_{DSS}	$V_{DS}=30V$, $V_{GS}=0V$	-	-	1	μA
		$T_J=85°C$	-	-	5	
Gate Leakage Current	I_{GSS}	$V_{DS}=0V$, $V_{GS}=\pm20V$	-	-	±100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	1.0	1.6	2.2	V
Drain-source on-state resistance	$R_{DS(ON)}$	$V_{GS}=10V$, $I_D=20A$	-	6.3	7.0	mΩ
		$V_{GS}=4.5V$, $I_D=20A$		8.8	9.5	
Forward Transconductance	g_{FS}	$V_{DS}=5V$,$I_D=20A$	20	-	-	S
Diode Characteristics						
Diode Forward Voltage	V_{SD}	$I_{SD}=1A$,$V_{GS}=0V$	-	0.7	1.2	V
Diode Continuous Forward Current	I_S		-	-	65	A
Reverse Recovery Time	t_{rr}	$T_J=25°C$, $I_F=I_S$ di/dt = 100A/μs	-	27	-	ns
Reverse Recovery Charge	Q_{rr}		-	20	-	nC
Dynamic Characteristics						
Gate Resistance	R_G	$V_{GS}=0V$, $V_{DS}=0V$,f=1MHz	-	2	4	Ω
IPECNut capacitance	C_{ISS}	$V_{GS}=0V$,$V_{DS}=30V$ f=1.0MHz	-	1400	-	pF
Output capacitance	C_{OSS}		-	205	-	
Reverse transfer capacitance	C_{RSS}		-	177	-	
Turn-on delay time	$t_{D(ON)}$	$V_{GS}=10V$, $V_{DS}=30V$, $R_L=1.5Ω$, $R_G=3Ω$	-	9	-	ns
Turn-on Rise time	tr		-	8	-	
Turn-off delay time	$t_{D(OFF)}$		-	28	-	
Turn-off Fall time	t_f		-	5	-	
Total gate charge	Q_g	$V_{GS}=10V$, $V_{DS}=30V$，$I_D=20A$	-	33	-	nC
Gate-source charge	Q_{gs}		-	5	-	
Gate-drain charge	Q_{gd}		-	7	-	

Thermal Characteristics

Parameter		Symbol	Typ	Max	Unit
Maximum Junction-to-Ambient[A]	≤ 10s	$R_{\theta JA}$	29	34	℃/W
Maximum Junction-to-Ambient[A]	Steady-State		56	66	
Maximum Junction-to-Lead[B]	Steady-State	$R_{\theta JC}$	3.2	4	

A:The value of R qJA is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T A=25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

B: The R qJA is the sum of the thermal impedance from junction to lead R qJL and lead to ambient.

Package Information

- **PDFN5*6-8L-A**

Top View
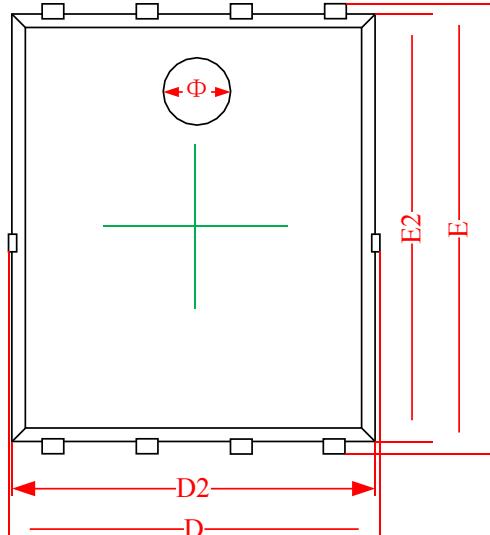
Bottom View
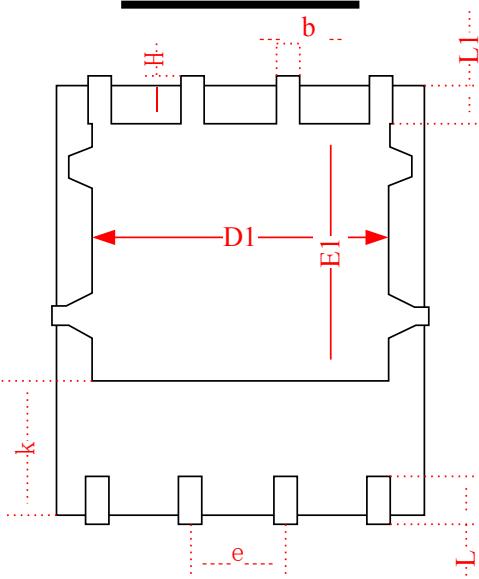
Side View
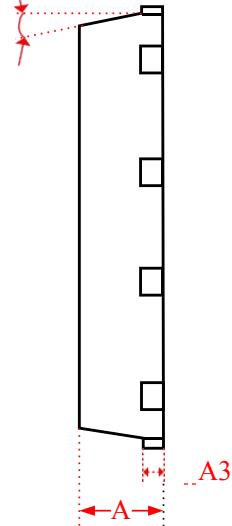
SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.870	0.900	0.930	0.034	0.035	0.036
A3	0.152REF.			0.006REF.		
D	4.944	5.020	5.096	0.195	0.198	0.201
E	5.974	6.050	6.126	0.235	0.238	0.241
D1	3.910	4.010	4.110	0.154	0.158	0.162
E1	3.375	3.475	3.575	0.133	0.137	0.141
D2	4.870	4.900	4.930	0.192	0.193	0.194
E2	5.720	5.750	5.780	0.226	0.227	0.228
k	1.190	1.290	1.390	0.047	0.051	0.055
b	0.350	0.380	0.410	0.014	0.015	0.016
e	1.270TYP.			0.050TYP.		
L	0.559	0.635	0.711	0.022	0.025	0.028
L1	0.424	0.500	0.576	0.017	0.020	0.023
H	0.574	0.650	0.726	0.023	0.026	0.029
θ	10°	11°	12°	10°	11°	12°
Φ	1.150	1.200	1.250	0.045	0.047	0.049